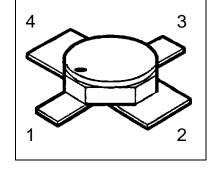


### HiRel NPN Silicon RF Transistor

- HiRel Discrete and Microwave Semiconductor
- For low noise, high-gain amplifiers up to 2GHz.
- For linear broadband amplifiers
- Hermetically sealed microwave package
- f<sub>T</sub>= 6,5 GHz F = 3 dB at 2 GHz

ESA/SCC Detail Spec. No.: 5611/006

Type Variant No. 07



**ESD**: Electrostatic discharge sensitive device, observe handling precautions!

| Туре        | Marking | Ordering Code | Pin | Conf | igura | tion | Package  |
|-------------|---------|---------------|-----|------|-------|------|----------|
| BFY196 (ql) | -       | see below     | С   | Е    | В     | Е    | Micro-X1 |

(ql) Quality Level: P: Professional Quality

ES: ESA Space Quality

(see order instructions for ordering example)



| B. 4 | •    | D - 41: |     |
|------|------|---------|-----|
| wax  | imum | Ratii   | nas |

| Parameter   | Symbol             | Values           | Unit |
|---|--------------------|------------------|------|
| Collector-emitter voltage                                 | $V_{CEO}$          | 12               | V    |
| Collector-emitter voltage, V <sub>BE</sub> =0             | V <sub>CES</sub>   | 20               | V    |
| Collector-base voltage                                    | V <sub>CBO</sub>   | 20               | V    |
| Emitter-base voltage                                      | V <sub>EBO</sub>   | 2                | V    |
| Collector current   | Ic                 | 100              | mA   |
| Base current  | I <sub>B</sub>     | 12 <sup>1)</sup> | mA   |
| Total power dissipation, $T_S \le 105^{\circ}C^{-2), 3)}$ | P <sub>tot</sub>   | 700              | mW   |
| Junction temperature                                      | T <sub>j</sub>     | 200              | °C   |
| Operating temperature range                               | T <sub>op</sub>    | -65+200          | °C   |
| Storage temperature range                                 | T <sub>stg</sub>   | -65+200          | °C   |
| Thermal Resistance  | •                  | •                |      |
| Junction-soldering point 3.)                              | R <sub>th JS</sub> | < 135            | K/W  |

# Notes.:

### **Electrical Characteristics**

at T<sub>A</sub>=25°C; unless otherwise specified

| Parameter                                    | Symbol           | Values |      | Unit |    |
|--|------------------|--------|------|------|----|
|  |                  | min.   | typ. | max. |    |
| DC Characteristics                           |                  |        |      |      |    |
| Collector-base cutoff current                | I <sub>CBO</sub> | -      | -    | 100  | μA |
| $V_{CB} = 20 \text{ V}, I_{E} = 0$           |                  |        |      |      |    |
| Collector-emitter cutoff current             | I <sub>CEX</sub> | -      | -    | 1000 | μA |
| $V_{CE} = 12 \text{ V}, I_B = 1 \mu A^{-1.}$ |                  |        |      |      |    |
| Collector-base cutoff current                | I <sub>CBO</sub> | -      | -    | 50   | nA |
| $V_{CB} = 10 \text{ V}, I_{E} = 0$           |                  |        |      |      |    |
| Emitter base cuttoff current                 | I <sub>EBO</sub> | -      | -    | 25   | μΑ |
| $V_{EB} = 2 \text{ V}, I_{C} = 0$            |                  |        |      |      |    |
| Emitter base cuttoff current                 | I <sub>EBO</sub> | -      | -    | 0.5  | μΑ |
| $V_{EB} = 1 \text{ V}, I_{C} = 0$            |                  |        |      |      |    |

### Notes:

1.) This Test assures V(BR)CE0 > 12V

<sup>1)</sup> The maximum permissible base current for V<sub>FBE</sub> measurements is 50mA (spotmeasurement duration < 1s)

<sup>2)</sup> At  $T_S = +\ 105$  °C. For  $T_S > +\ 105$  °C derating is required. 3)  $T_S$  is measured on the collector lead at the soldering point to the pcb.



## **Electrical Characteristics** (continued)

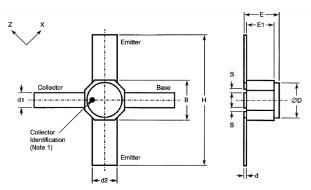
| Parameter   | Symbol                   |      | Values |      | Unit |
|---|--------------------------|------|--------|------|------|
|   |                          | min. | typ.   | max. |      |
| DC Characteristics  | <u> </u>                 |      |        | •    |      |
| Base-Emitter forward voltage  | $V_{FBE}$                | -    | -      | 1    | V    |
| $I_E = 50 \text{ mA}, I_C = 0$                                      |                          |      |        |      |      |
| DC current gain   | h <sub>FE</sub>          | 50   | 100    | 175  | -    |
| $I_{C} = 50 \text{ mA}, V_{CE} = 8 \text{ V}$                       |                          |      |        |      |      |
| AC Characteristics  |                          |      |        |      |      |
| Transition frequency  | f <sub>T</sub>           | 6    | 6.5    | -    | GHz  |
| $I_C = 70$ mA, $V_{CE} = 5$ V, $f = 500$ MHz                        |                          |      |        |      |      |
| Collector-base capacitance  | ССВ                      | -    | 1      | 1.3  | pF   |
| $V_{CB} = 10 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$ |                          |      |        |      |      |
| Collector-emitter capacitance                                       | C <sub>CE</sub>          | -    | 0.44   | -    | pF   |
| $V_{CE} = 10 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$ |                          |      |        |      |      |
| Emitter-base capacitance  | C <sub>EB</sub>          | -    | 3,6    | 4,3  | pF   |
| $V_{EB} = 0.5V$ , $V_{CB} = vcb = 0$ , $f = 1 \text{ MHz}$          |                          |      |        |      |      |
| Noise Figure  | F                        | -    | 3      | 3.5  | dB   |
| $I_C = 20 \text{ mA}, V_{CE} = 5 \text{ V}, f = 2 \text{ GHz},$     |                          |      |        |      |      |
| $Z_S = Z_{Sopt}$  |                          |      |        |      |      |
| Power gain  | Gma 1.)                  | 10   | 11     | -    | dB   |
| $I_C = 70 \text{ mA}, V_{CE} = 5V, f = 2 \text{ GHz}$               |                          |      |        |      |      |
| $Z_S = Z_{Sopt}$ , $Z_L = Z_{Lopt}$                                 |                          |      |        |      |      |
| Transducer gain   | $\left S_{21e}\right ^2$ | 4    | 5      | -    | dB   |
| $I_C$ = 70 mA, $V_{CE}$ = 5 V, f = 2 GHz                            |                          |      |        |      |      |
| $Z_S = Z_L = 50 \Omega$   |                          |      |        |      |      |
| Output Power  | P <sub>OUT</sub>         | 18.5 | 19.5   | -    | dBm  |
| $I_C$ = 80 mA, $V_{CE}$ = 5 V, f = 2 GHz ,                          |                          |      |        |      |      |
| $P_{IN}$ =15 dBm, $Z_S = Z_L = 50 \Omega$                           |                          |      |        |      |      |

## Notes.:

1) 
$$G_{ma} = \left| \frac{S21}{S12} \right| (k - \sqrt{k^2 - 1}), \quad G_{ms} = \left| \frac{S21}{S12} \right|$$



## Micro-X1 Package



| Symbols | Dimensions mm |      |  |  |
|---------|---------------|------|--|--|
|         | Min           | Max  |  |  |
| В       | 1.68          | 1.88 |  |  |
| d       | 0.07          | 0.15 |  |  |
| d1      | 0.4           | 0.6  |  |  |
| d2      | 0.92          | 1.12 |  |  |
| ØD      | 1.55          | 1.85 |  |  |
| E       | 0.85          | 1.25 |  |  |
| E1      | 0.66          | 0.86 |  |  |
| Н       | 4             | 4.4  |  |  |
| S       | 0.08          | 0.3  |  |  |

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